**PATENT** IN-THE UNITED STATES PATENT AND TRADEMARK OFFICE

(Case No. 03-264-A)

In the Application of:

Wan et al.

Serial No.

To be assigned

Filed:

February 27, 2004

For:

Vertical Die Chip-on-Board

2 Examiner: TBD

Art Unit: TBD

# TRANSMITTAL LETTER

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In regard to the above identified application:

- 1. We are transmitting herewith the attached:
  - Information Disclosure Statement (IDS) (2 sheets);
  - Form PTO-1449 (1 sheets); b.
  - 1 Cited References; and c.
  - Return Receipt Postcard. d.
- 2. With respect to fees:
  - X No fee is required
- 3. Please charge any additional fees or credit overpayment to Deposit Account No. 13-2490.
- 4. CERTIFICATE OF MAILING UNDER 37 CFR § 1.8: The undersigned hereby certifies that this Transmittal Letter and the paper, as described in paragraph 1 hereinabove, are being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June <u>2</u>, 2004.

Respectfully submitted,

Jeffrey D. Anderson

Reg./No. 51,403

McDonnell, Boehnen Hulbert & Berghoff LLP

300 South Wacker Drive

Chicago, IL 60606

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE (Case No. 03-264-A)

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Serial No.	To be assigned	)
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# INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. Section 1.97 - 1.99, the Applicant wishes to make the following references of record in the above-identified application. This Information Disclosure Statement is in compliance with the continuing duty of candor as set forth in 37 C.F.R. Section 1.56. Copies of the references cited below are enclosed. These references are also listed on the enclosed PTO Form 1449.

In the judgment of the undersigned, portions of the listed references may be material to the Examiner's consideration of the presently pending claims. However, the references have not been reviewed in sufficient detail to make any other representation and, in particular, no representation is intended as to the relative relevance between references, whether cited in this or prior statements. This statement is not a representation that the listed references have effective dates early enough to be "prior art" within the meaning of 35 U.S.C. Section 102 or Section 103.

## **Other Documents**

1. Van Zant, Microchip Fabrication, 4th Edition; McGraw-Hill (2000); Chapter 18, pp.557-593.

In accordance with MPEP Sections 609 and 707.05(b), it is requested the document cited (including any cited in applicant's specification which is not repeated on the attached Form PTO-1449) be given thorough consideration and that it be cited of record in the prosecution history of the present application by initialing on Form PTO-1449. Such initialing is requested even if the Examiner does not consider a cited document to be sufficiently pertinent to use in a rejection, or otherwise does not consider it to be prior art for any reason, or even if the Examiner does not believe that the guidelines for citation have been fully complied with. This is requested so that each document becomes listed on the face of the patent issuing on the present application.

Respectfully submitted,

Date: June 21, 2004

By:

Jeffre D. Anderson

Reg. No. 51,403

McDonnell, Boehnen Hulbert & Berghoff LLP 300 South Wacker Drive Chicago, IL 60606

Applicant: Wan et al.	FORM PTO-1449 (Rev. 2-32)	U.S. Department of Commerce Patent and Trademark Office  INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)	Atty. Docket No. 03-264-A	Serial No.  To be assigned
Filing Date: Group		JUN 2 5 200. 05		
		TO TO EMARK CHIEF	Filing Date:	Group:  To be assigned

#### **U.S. PATENT APPLICATION DOCUMENTS**

Examiner Initial	Document Number	Filing Date	Name	Class	Subclas s	Publication Date if Appropriate

#### **U.S. PATENT DOCUMENTS**

Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date if Appropriate

#### **FOREIGN PATENT DOCUMENTS**

Examiner Initial	Document Number	Date	Country	Class	Subclass	Trans Yes	slation No

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc).

	1.	Van Zant, Microchip Fabrication, 4th Edition; McGraw-Hill (2000); Chapter 18, pp.557-593		
EXAMINER	•		DATE CONSIDERED	

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication.